Electronic Acknowledgement Receipt

EFS ID:	1168985
Application Number:	10802067
Confirmation Number:	3775
Title of Invention:	RECONFIGURABLE PROCESSOR MODULE COMPRISING HYBRID STACKED INTEGRATED CIRCUIT DIE ELEMENTS
First Named Inventor:	Jon M. Huppenthal
Customer Number:	25235
Filer:	William J. Kubida/Julie Lange
Filer Authorized By:	William J. Kubida
Attorney Docket Number:	ARB001 CON/CIP
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Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		DOC020.PDF	258892	yes	6

	Multipart Description		
	Doc Desc	**Start**	**End**
	Letter to Official Draftsman Filed P/E	1	1
	Drawings	2	6

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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371
If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.